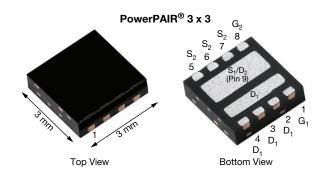


Vishay Siliconix

# Dual N-Channel 30 V (D-S) MOSFET



PRODUCT SUMMARY					
MOSFET CHANNEL-1 AND CHANNEL-2					
V <sub>DS</sub> (V)	30				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.0094				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.0144				
Q <sub>g</sub> typ. (nC)	3.7				
I <sub>D</sub> (A)	33.4 <sup>a</sup>				
Configuration	Dual				

#### **FEATURES**

• TrenchFET® Gen IV power MOSFET



 High side and low side MOSFETs form optimized combination for 50 % duty cycle

RoHS COMPLIANT

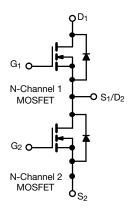
 • Optimized  $R_{DS}$  -  $Q_g$  and  $R_{DS}$  -  $Q_{gd}$  FOM elevates efficiency for high frequency switching

HALOGEN FREE

- 100 % R<sub>a</sub> and UIS tested
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

### **APPLICATIONS**

- Synchronous buck
- DC/DC conversion
- Half bridge
- POL



ORDERING INFORMATION	
Package	PowerPAIR 3 x 3
Lead (Pb)-free and halogen-free	SiZ342ADT-T1-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> $(T_A = 25  {}^{\circ}C$	C, unless other	wise noted)			
PARAMETER		CHANNEL-1 AND CHANNEL-2			
		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	30	.,,	
Gate-source voltage		V <sub>GS</sub>	+20 / -16		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		33.4		
	T <sub>C</sub> = 70 °C		26.7		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	15.7 b, c		
	T <sub>A</sub> = 70 °C		12.5 b, c		
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	100	A	
	T <sub>C</sub> = 25 °C		13.9		
Continuous source current (MOSFET diode conduction)	T <sub>A</sub> = 25 °C	I <sub>S</sub>	3.1 b, c		
Single pulse avalanche current		I <sub>AS</sub>	10		
Single pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	5	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C		16.7		
	T <sub>C</sub> = 70 °C	_	10.7	14/	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.7 b, c	w	
	T <sub>A</sub> = 70 °C		2.4 b, c		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150		
Soldering recommendations (peak temperature)	Ŭ .	260	→ °C		

#### Notes

a.  $T_C = 25 \,^{\circ}C$ 

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s



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THERMAL RESISTANCE RATINGS						
PARAMETER		CHANNEL-1 AND CHANNEL-2				
		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient a, b	t ≤ 10 s	R <sub>thJA</sub>	27	34	°C/W	
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	6	7.5	G/ <b>VV</b>	

#### **Notes**

- a. Surface mounted on 1" x 1" FR4 board
- b. Maximum under steady state conditions is 69 °C/W

<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C	CHANNEL-1 AND CHANNEL-2						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30	-	-	V	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	-	2.4	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = +20 \text{ V} / -16 \text{ V}$	-	-	± 100	nA	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V	-	-	1	μA	
Zero gato voltago aram ourrem	פסטי	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$	-	-	5	μA	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30	-	-	Α	
Drain-source on-state resistance a	Brack N	$V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	1	0.0078	0.0094	Ω	
Dialii-Source on-State resistance	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 7 \text{ A}$	-	0.0120	0.0144		
Forward transconductance a	9 <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_D = 10 \text{ A}$	-	57	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	580	-	pF	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	250	-		
Reverse transfer capacitance	C <sub>rss</sub>	V <sub>DS</sub> = 13 V, V <sub>GS</sub> = 0 V, I = 1 IVIH2	-	30	-		
C <sub>rss</sub> /C <sub>iss</sub> ratio			-	0.052	0.103		
Total gate charge	0	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15.7 A	ı	8.1	12.2	nC	
Total gate charge	$Q_g$		ı	3.7	4.5		
Gate-source charge	$Q_{gs}$	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 15.7 \text{ A}$	-	2.4	-		
Gate-drain charge	$Q_{gd}$		-	0.67	-		
Gate resistance	$R_g$	f = 1 MHz	0.24	1.2	2.4	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	10	20		
Rise time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, R_L = 1.2 \Omega, I_D \cong 12.5 \text{ A},$	-	6	12		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	18	36		
Fall time	t <sub>f</sub>		-	8	16		
Turn-on delay time	t <sub>d(on)</sub>		-	15	30	ns	
Rise time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, R_L = 1.2 \Omega, I_D \cong 12.5 \text{ A},$	-	180	360		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	20	40		
Fall time	t <sub>f</sub>	]	-	15	30		



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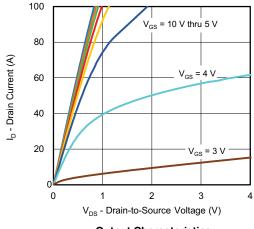
SPECIFICATIONS (T <sub>J</sub> = 25 °C, unless otherwise noted)						
PARAMETER	CHANNEL-1 AND CHANNEL-2					
PANAIVIE I EN	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain-source Body Diode Characteristics						
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25°C	-	13.9	Δ.	
Pulse diode forward current	I <sub>SM</sub>		-	-	100	Α
Body diode voltage	$V_{SD}$	$I_S = 12.5 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.85	1.2	V
Body diode reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = 12.5 A, di/dt = 100 A/μs, T <sub>J</sub> = 25 °C	-	15	30	ns
Body diode reverse recovery charge	Q <sub>rr</sub>		-	4.3	8.6	nC
Reverse recovery fall time	ta		-	8	-	no
Reverse recovery rise time	t <sub>b</sub>		-	7	-	ns

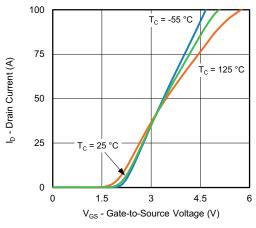
### **Notes**

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

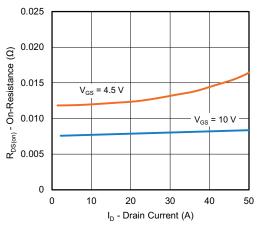


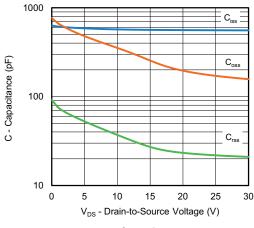






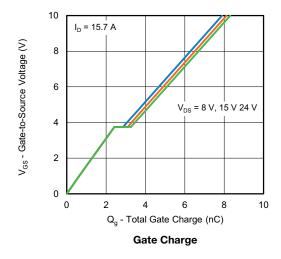


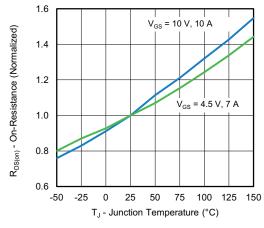




On-Resistance vs. Drain Current and Gate

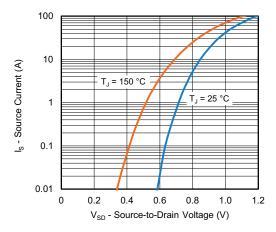




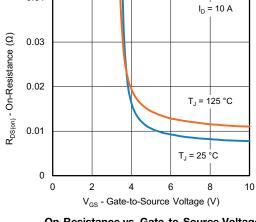


On-Resistance vs. Junction Temperature



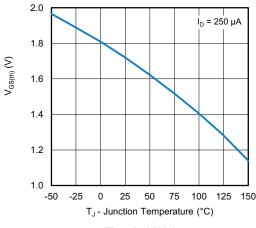


Source-Drain Diode Forward Voltage

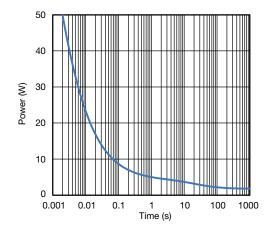


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On-Resistance vs. Gate-to-Source Voltage

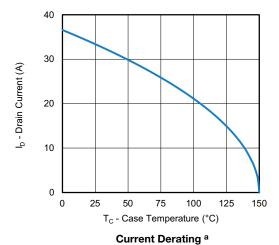


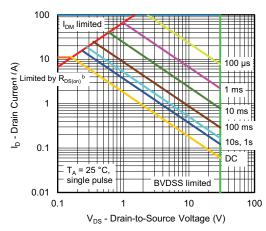
**Threshold Voltage** 



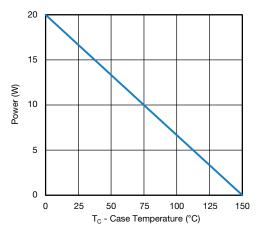
Single Pulse Power

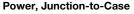


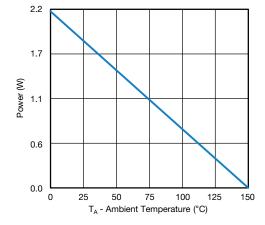




Safe Operating Area, Junction-to-Ambient





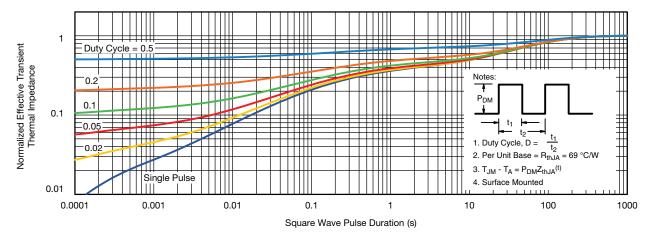


Power, Junction-to-Ambient

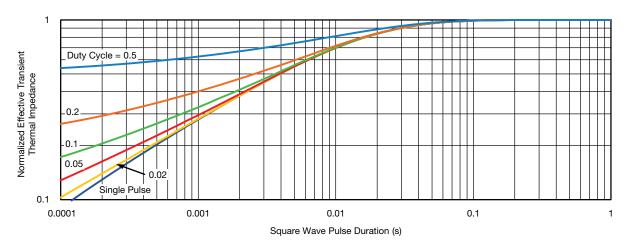
#### Notes

- a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-ambient thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit
- b.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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